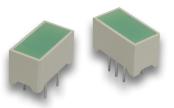


DE2CGKD

7.5 mm x 14 mm Light Bar



DESCRIPTIONS

- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- · Uniform light emitting area
- · Easily mounted on P.C. boards or industry standard sockets
- Flush mountable
- Excellent on/off contrast
- · Can be used with panels and legend mounts
- · Mechanically rugged
- RoHS compliant

APPLICATIONS

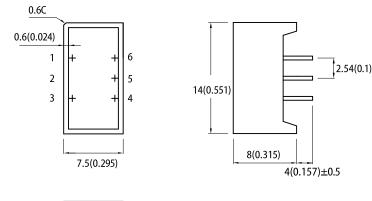
- · Home and smart appliances
- · Display time and digital combination
- · Industrial and instrumental applications
- Numeric status

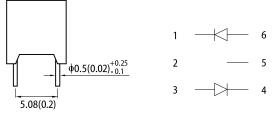
ATTENTION

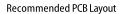
Observe precautions for handling electrostatic discharge sensitive devices

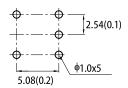


PACKAGE DIMENSIONS











All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
The specifications, characteristics and technical data described in the datasheet are subject to change

without prior notice

SELECTION GUIDE

| Part Number | Emitting Color | | lv (mcd) @ 20mA ^[1] | |
|-------------|-----------------|----------------|--------------------------------|------|
| Fait Number | (Material) | Lens Type | Min. | Тур. |
| DE2CGKD | Green (AlGaInP) | Green Diffused | 120 | 200 |
| | | | *20 | *54 |

- Notes: 1. Luminous intensity / luminous Flux: +/-15%. * Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

| Parameter | Symbol | Emitting Color | Value | | Unit |
|--|--------------------------------|----------------|-------|------|------|
| | | | Тур. | Max. | Unit |
| Wavelength at Peak Emission I_F = 20mA | λ_{peak} | Green | 574 | - | nm |
| Dominant Wavelength $I_F = 20 \text{mA}$ | λ_{dom} ^[1] | Green | 570 | - | nm |
| Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA | Δλ | Green | 20 | - | nm |
| Capacitance | С | Green | 15 | - | pF |
| Forward Voltage I_F = 20mA | V _F ^[2] | Green | 2.1 | 2.5 | V |
| Reverse Current (V _R = 5V) | I _R | Green | - | 10 | μΑ |

Notes:

Notes: 1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.) 2. Forward voltage: ±0.1V. 3. Wavelength value is traceable to CIE127-2007 standards. 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

| Parameter | Symbol | Value | Unit |
|--|--------------------------------|-----------------------|------|
| Power Dissipation | P _D | 75 | mW |
| Reverse Voltage | V _R | 5 | V |
| Junction Temperature | Tj | 115 | °C |
| Operating Temperature | T _{op} | -40 to +85 | °C |
| Storage Temperature | T _{stg} | -40 to +85 | °C |
| DC Forward Current | I _F | 30 | mA |
| Peak Forward Current | I _{FM} ^[1] | 150 | mA |
| Electrostatic Discharge Threshold (HBM) | - | 3000 | V |
| Lead Solder Temperature ^[2] 260°C For 3-5 Seconds | | 260°C For 3-5 Seconds | • |

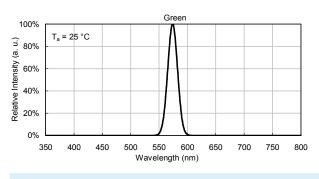
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base. 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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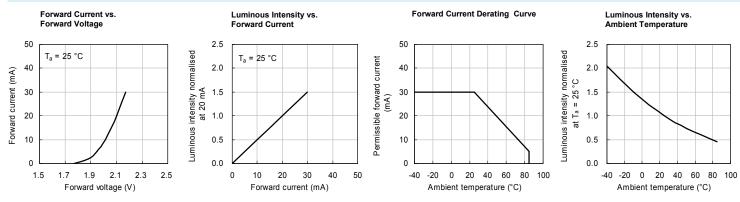
DE2CGKD

TECHNICAL DATA

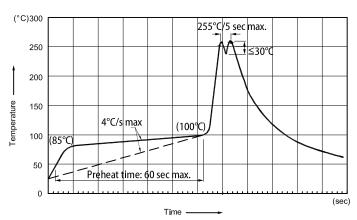




GREEN



RECOMMENDED WAVE SOLDERING PROFILE



Notes:

 Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C

3. Do not apply stress to the epoxy resin while the temperature is above 85°C.

4. Fixtures should not incur stress on the component when mounting and during soldering process.

- 5. SAC 305 solder allov is recommended.

Soldering General Notes

1. Through-hole displays are incompatible with reflow soldering.

2. If components will undergo multiple soldering processes, or other processes where the components may be subjected

to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1. Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning because they may damage the plastic parts .
- 3. The cleaning process should take place at room temperature and the devices should not be washed for more than one minute.
- 4. When water is used in the cleaning process, Immediately remove excess moisture from the component with forced-air drying afterwards.

Peak wave soldering temperature between 245°C ~ 255°Cfor 3 sec (5 sec max).

No more than one wave soldering pass.
During wave soldering, the PCB top-surface temperature should be kept below 105°C.